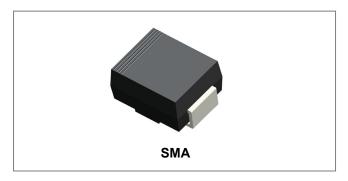


Technical Data Data Sheet N2018, Rev. A





# US1A THRU US1K SURFACE MOUNT ULTRA FAST RECTIFIER



#### **Features**

- Ideally Suited for Automatic Assembly
- Low Forward Overload Drop, High Efficiency
- Low Power Loss
- Super-Fast Recovery Time
- Plastic Material has UL Classification 94V-O
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

## **Circuit Diagram**



#### **Mechanical Data**

- Case: Low Profile Molded Plastic
- Terminals: Solder Plated, Solderable per MIL-STD-750, Method 2026
- Polarity: Cathode Band or Cathode Notch
- Weight: 0.06 grams(approx)

#### Maximum Ratings and Electrical Characteristics @TA=25°C unless otherwise specified

Characteristic	Symbol	US1A	US1B	US1D	US1G	US1J	US1K	Units
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	560	<b> </b>
Average Rectified Output Current @T <sub>L</sub> =100°C	lo				1.0			Α
Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>				35			А
Rating for fusing (t<8.3ms)	l²t	5.08			A <sup>2</sup> s			
Forward voltage* @IF =1.0A	V <sub>F</sub>		1.0		1.3	1.	7	V
Peak Reverse Current * @T <sub>A</sub> = 25°C At Rated DC Blocking Voltage @T <sub>A</sub> = 125°C	I <sub>R</sub>	5 100			μА			
Typical junction capacitance (Note 2)	CJ	6		pF				
Reverse Recovery Time (Note 1)	Trr	50		7:	5	ns		
Typical thermal resistance (Note 3)	R <sub>θJA</sub>	112		°C/W				
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 to +150		°C				

<sup>\*</sup> Pulse width < 300 µs, duty cycle < 2%

Note: 1.Reverse Recovery Test Conditions: IF=0.5A, IR=1.0A, IRR=0.25A.

- 2. Measured at 1.0 MHz and Applied reverse Voltage of 4.0V D.C
- 3. Mounted on an FR4 PCB, single-sided copper, mini pad.
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       sales@ smc-diodes.com



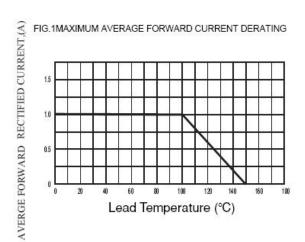


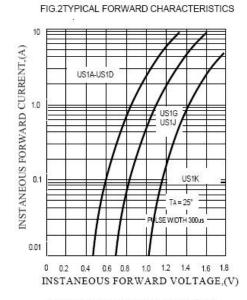
**Technical Data** Data Sheet N2018, Rev. A



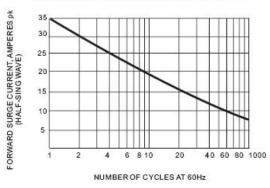


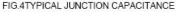
## **Ratings and Characteristics Curves**

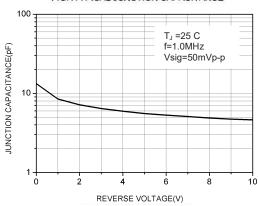




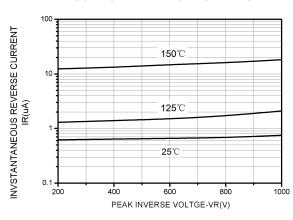


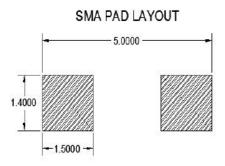






#### FIG.5TYPICAL REVERSE CHRACTERISTICS





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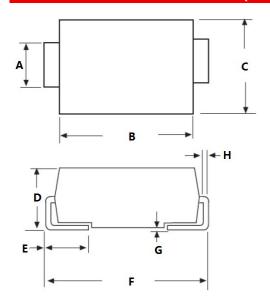


Technical Data Data Sheet N2018, Rev. A





### **Mechanical Dimensions SMA (Inches/Millimeters)**



	mechanical size (mm)			
Item	MIN	MAX	MIN	MAX
А	1.25	1.65	0.049	0.065
В	3.95	4.6	0.156	0.181
С	2.25	2.95	0.089	0.116
D	1.95	2.9	0.077	0.114
Е	0.75	1.6	0.03	0.063
F	4.8	5.6	0.189	0.22
G	0.05	0.2	0.002	0.008
Н	0.15	0.41	0.006	0.016

### **Ordering Information**

Device	Package	Shipping
US1A THRU US1K	SMA (Pb-Free)	5000pcs / reel
US1ATR THRU US1KTR	SMA (Pb-Free)	5000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

#### **Marking Diagram**



Where XXXXX is YYWWL

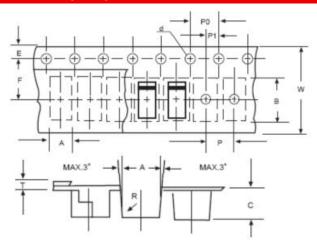
US = Device Type
1 = Forward Current (1A)
A = Reverse Voltage (50V)
YY = Year

WW = Week
L = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

## **Carrier Tape Specification SMA**



SYMBOL	Millimeters			
STWIBUL	Min.	Max.		
Α	2.97	3.17		
В	5.70	5.90		
С	2.32	2.52		
d	1.40	1.60		
E	1.40	1.60		
F	5.60	5.70		
Р	3.90	4.10		
P0	3.90	4.10		
P1	1.90	2.10		
Т	0.25	0.35		
W	11.80	12.20		

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#### **US1A THRU US1K**

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